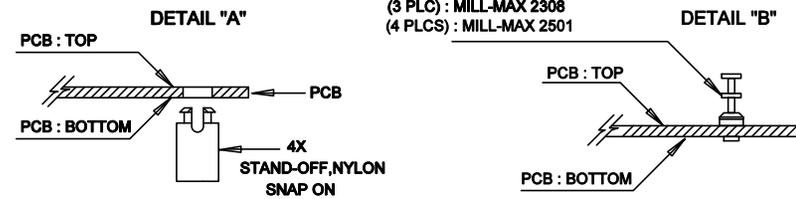
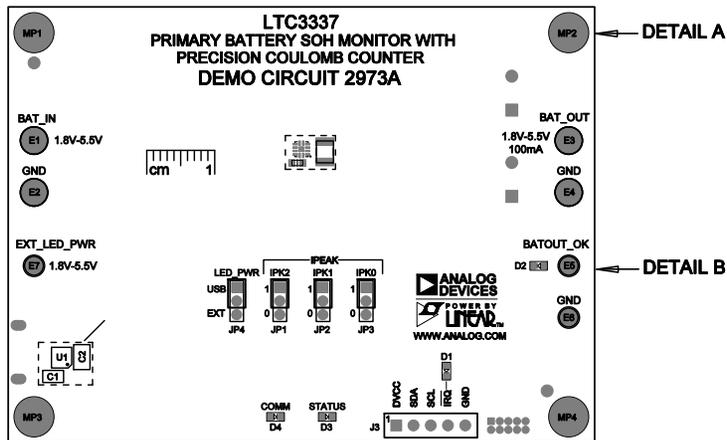


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
-	02	PRODUCTION	ZP	4-23-2020

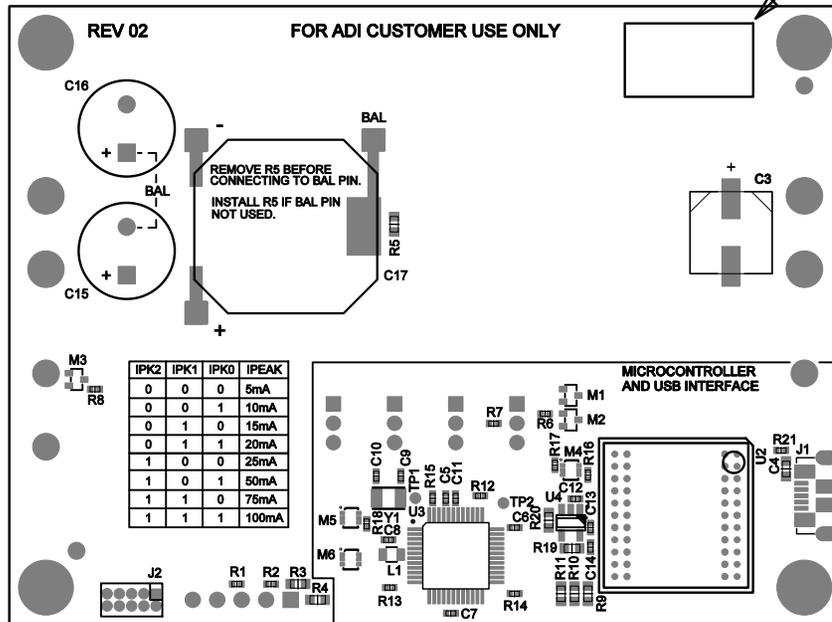
**NOTES: UNLESS OTHERWISE SPECIFIED**

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY REFLOW PROFILE SHALL BE IN ACCORDANCE WITH J-STD-020 WITH MAXIMUM SOLDER TEMPERATURE OF 250 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS  
LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER.  
MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. APPLY ASSEMBLY STAMP OR QA STAMP TO BOTTOM OF BOARD (UNSHOWY AREA).
7. INSTALL TURRETS, STAND-OFFS AS SHOWN BELOW:
8. APPLY DEMO S/N AT AREA ON BOTTOM SIDE AS SHOWN ON SHEET 2.



APPROVALS		ANALOG DEVICES		POWER BY LINEAR	
PCB DES	NC	FOR ADI CUSTOMER USE ONLY			
APP ENG	ZP	TITLE: TOP ASSEMBLY DRAWING PRIMARY BATTERY SOH MONITOR WITH PRECISION COULOMB COUNTER			
		SIZE	IC NO.	LTC3337	REV.
		N/A		DEMO CIRCUIT 2973A	01
SCALE = NONE					SHT 1 OF 1

8 DEMO S/N LABEL  
APPLY IN THIS AREA



APPROVALS		ANALOG DEVICES		POWER BY LINEAR™	
PCB DES.	NC	FOR ADI CUSTOMER USE ONLY			
APP ENG.	ZP	TITLE: BOTTOM ASSEMBLY DRAWING PRIMARY BATTERY SOH MONITOR WITH PRECISION COULOMB COUNTER			
		SIZE	IC NO.	LTC3337	REV
		N/A		DEMO CIRCUIT 2973A	02
SCALE = NONE					SHT 2 of 2